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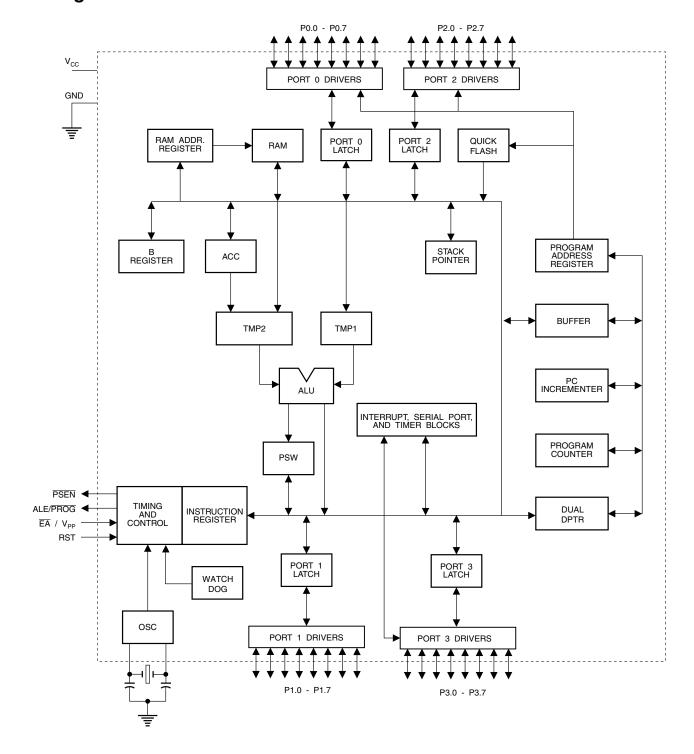
What is "Embedded - Microcontrollers"?

"Embedded - Microcontrollers" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "<u>Embedded - Microcontrollers</u>"

Details	
Product Status	Obsolete
Core Processor	8051
Core Size	8-Bit
Speed	24MHz
Connectivity	UART/USART
Peripherals	WDT
Number of I/O	32
Program Memory Size	20KB (20K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	256 x 8
Voltage - Supply (Vcc/Vdd)	4.5V ~ 5.5V
Data Converters	-
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	44-TQFP
Supplier Device Package	44-TQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/at89c55wd-24ai

Block Diagram







Pin Description

VCC Supply voltage.

GND Ground.

Port 0 Port 0 is an 8-bit open drain bi-directional I/O port. As an output port, each pin can sink eight TTL inputs. When 1s are written to port 0 pins, the pins can be used as high-impedance

inputs.

Port 0 can also be configured to be the multiplexed low-order address/data bus during accesses to external program and data memory. In this mode, P0 has internal pull-ups.

Port 0 also receives the code bytes during Flash programming and outputs the code bytes during program verification. External pull-ups are required during program verification.

Port 1 is an 8-bit bi-directional I/O port with internal pull-ups. The Port 1 output buffers can sink/source four TTL inputs. When 1s are written to Port 1 pins, they are pulled high by the internal pull-ups and can be used as inputs. As inputs, Port 1 pins that are externally being pulled low will source current (I_{II}) because of the internal pull-ups.

> In addition, P1.0 and P1.1 can be configured to be the timer/counter 2 external count input (P1.0/T2) and the timer/counter 2 trigger input (P1.1/T2EX), respectively, as shown in the following table.

Port 1 also receives the low-order address bytes during Flash programming and verification.

Port Pin	Alternate Functions
P1.0	T2 (external count input to Timer/Counter 2), clock-out
P1.1	T2EX (Timer/Counter 2 capture/reload trigger and direction control)

Port 2 is an 8-bit bi-directional I/O port with internal pull-ups. The Port 2 output buffers can sink/source four TTL inputs. When 1s are written to Port 2 pins, they are pulled high by the internal pull-ups and can be used as inputs. As inputs, Port 2 pins that are externally being pulled low will source current (I_{II}) because of the internal pull-ups.

Port 2 emits the high-order address byte during fetches from external program memory and during accesses to external data memory that use 16-bit addresses (MOVX @ DPTR). In this application, Port 2 uses strong internal pull-ups when emitting 1s. During accesses to external data memory that use 8-bit addresses (MOVX @ RI), Port 2 emits the contents of the P2 Special Function Register.

Port 2 also receives the high-order address bits and some control signals during Flash programming and verification.

Port 3 is an 8-bit bi-directional I/O port with internal pull-ups. The Port 3 output buffers can sink/source four TTL inputs. When 1s are written to Port 3 pins, they are pulled high by the internal pull-ups and can be used as inputs. As inputs, Port 3 pins that are externally being pulled low will source current (I_{II}) because of the pull-ups.

Port 3 receives some control signals for Flash programming and verification.

Port 3 also serves the functions of various special features of the AT89C55WD, as shown in the following table.

Port 1

Port 2

Port 3

Port Pin	Alternate Functions
P3.0	RXD (serial input port)
P3.1	TXD (serial output port)
P3.2	ĪNTO (external interrupt 0)
P3.3	INT1 (external interrupt 1)
P3.4	T0 (timer 0 external input)
P3.5	T1 (timer 1 external input)
P3.6	WR (external data memory write strobe)
P3.7	RD (external data memory read strobe)

RST

Reset input. A high on this pin for two machine cycles while the oscillator is running resets the device. This pin drives High for 98 oscillator periods after the Watchdog times out. The DIS-RTO bit in SFR AUXR (address 8EH) can be used to disable this feature. In the default state of bit DISRTO, the RESET HIGH out feature is enabled.

ALE/PROG

Address Latch Enable is an output pulse for latching the low byte of the address during accesses to external memory. This pin is also the program pulse input (PROG) during Flash programming.

In normal operation, ALE is emitted at a constant rate of 1/6 the oscillator frequency and may be used for external timing or clocking purposes. Note, however, that one ALE pulse is skipped during each access to external data memory.

If desired, ALE operation can be disabled by setting bit 0 of SFR location 8EH. With the bit set, ALE is active only during a MOVX or MOVC instruction. Otherwise, the pin is weakly pulled high. Setting the ALE-disable bit has no effect if the microcontroller is in external execution mode.

PSEN

Program Store Enable is the read strobe to external program memory.

When the AT89C55WD is executing code from external program memory, $\overline{\text{PSEN}}$ is activated twice each machine cycle, except that two $\overline{\text{PSEN}}$ activations are skipped during each access to external data memory.

EA/VPP

External Access Enable. $\overline{\mathsf{EA}}$ must be strapped to GND in order to enable the device to fetch code from external program memory locations starting at 0000H up to FFFFH. Note, however, that if lock bit 1 is programmed, $\overline{\mathsf{EA}}$ will be internally latched on reset.

 $\overline{\mathsf{EA}}$ should be strapped to V_{CC} for internal program executions.

This pin also receives the 12V programming enable voltage (V_{PP}) during Flash programming.

XTAL1

Input to the inverting oscillator amplifier and input to the internal clock operating circuit.

XTAL2

Output from the inverting oscillator amplifier.





Table 1. AT89C55WD SFR Map and Reset Values

									-
0F8H									0FFH
0F0H	B 00000000								0F7H
0E8H									0EFH
0E0H	ACC 00000000								0E7H
0D8H									0DFH
0D0H	PSW 00000000								0D7H
0C8H	T2CON 00000000	T2MOD XXXXXX00	RCAP2L 00000000	RCAP2H 00000000	TL2 00000000	TH2 00000000			0CFH
0C0H									0C7H
0B8H	IP XX000000								0BFH
0B0H	P3 11111111								0B7H
0A8H	IE 0X000000								0AFH
0A0H	P2 11111111		AUXR1 XXXXXXX0				WDTRST XXXXXXXX		0A7H
98H	SCON 00000000	SBUF XXXXXXXX							9FH
90H	P1 11111111								97H
88H	TCON 00000000	TMOD 00000000	TL0 00000000	TL1 00000000	TH0 00000000	TH1 00000000	AUXR XXX00XX0		8FH
80H	P0 11111111	SP 00000111	DP0L 00000000	DP0H 00000000	DP1L 00000000	DP1H 00000000		PCON 0XXX0000	87H

Special Function Registers

A map of the on-chip memory area called the Special Function Register (SFR) space is shown in Table 1.

Note that not all of the addresses are occupied, and unoccupied addresses may not be implemented on the chip. Read accesses to these addresses will in general return random data, and write accesses will have an indeterminate effect.

User software should not write 1s to these unlisted locations, since they may be used in future products to invoke new features. In that case, the reset or inactive values of the new bits will always be 0.

Timer 2 Registers: Control and status bits are contained in registers T2CON (shown in Table 2) and T2MOD (shown in Table 2) for Timer 2. The register pair (RCAP2H, RCAP2L) are the Capture/Reload registers for Timer 2 in 16-bit capture mode or 16-bit auto-reload mode.

Interrupt Registers: The individual interrupt enable bits are in the IE register. Two priorities can be set for each of the six interrupt sources in the IP register.

Table 2. T2CON—Timer/Counter 2 Control Register

T2CON Address = 0C8H Reset Value = 0000 0000B								
Bit Add	ressable							
Bit	TF2	EXF2	RCLK	TCLK	EXEN2	TR2	C/T2	CP/RL2
	7	6	5	4	3	2	1	0

Table 3. AUXR: Auxiliary Register

AUXR	Address = 8EH Reset Value = XXX00XX0B								
	Not Bit	Addressable							
		_	_	_	WDIDLE	DISRTO	_	_	DISALE
	Bit	7	6	5	4	3	2	1	0
_	Reserved fo	Reserved for future expansion							
DISALE	Disable/Ena	ble ALE							
	DISALE	Operating	Mode						
	0	ALE is emitted at a constant rate of 1/6 the oscillator frequency							
	1	ALE is act	ive only dur	ing a MOV	or MOVC in	struction			
DISRTO	Disable/Ena	ble Reset ou	t						
	DISRTO	Operating	Mode						
	0	Reset pin	is driven Hi	gh after WD	T times out				
	1	Reset pin	is input only	/					
WDIDLE	Disable/Ena	ble WDT in I	DLE mode						
	WDIDLE	Operating	Mode						
	0	WDT cont	inues to cou	unt in IDLE	mode				
	1	WDT halts	counting ir	IDLE mod	e				

Dual Data Pointer Registers: To facilitate accessing both internal and external data memory, two banks of 16-bit Data Pointer Registers are provided: DP0 at SFR address locations 82H-83H and DP1 at 84H-85H. Bit DPS = 0 in SFR AUXR1 selects DP0 and DPS = 1 selects DP1. The user should always initialize the DPS bit to the appropriate value before accessing the respective Data Pointer Register.

Power Off Flag: The Power Off Flag (POF) is located at bit 4 (PCON.4) in the PCON SFR. POF is set to "1" during power up. It can be set and rest under software control and is not affected by reset.



Table 4. AUXR1: Auxiliary Register 1

AUXR1	Address	s = A2H			Reset Value = XXXXXXX0B						
	Not Bit A	Not Bit Addressable									
		_	_	_	_	DPS					
	Bit	7	6	5	4	3	2	1	0		
_	Reserved for	future expa	ansion								
DPS	Data Pointer	Register S	elect								
	DPS										
	0	0 Selects DPTR Registers DP0L, DP0H									
	1	1 Selects DPTR Registers DP1L, DP1H									

Memory Organization

MCS-51 devices have a separate address space for Program and Data Memory. Up to 64 Kbytes each of external Program and Data Memory can be addressed.

Program Memory

If the \overline{EA} pin is connected to GND, all program fetches are directed to external memory.

On the AT89C55WD, if $\overline{\text{EA}}$ is connected to V_{CC}, program fetches to addresses 0000H through 4FFFH are directed to internal memory and fetches to addresses 5000H through FFFFH are to external memory.

Data Memory

The AT89C55WD implements 256 bytes of on-chip RAM. The upper 128 bytes occupy a parallel address space to the Special Function Registers. That means the upper 128 bytes have the same addresses as the SFR space but are physically separate from SFR space.

When an instruction accesses an internal location above address 7FH, the address mode used in the instruction specifies whether the CPU accesses the upper 128 bytes of RAM or the SFR space. Instructions that use direct addressing access SFR space.

For example, the following direct addressing instruction accesses the SFR at location 0A0H (which is P2).

MOV 0A0H, #data

Instructions that use indirect addressing access the upper 128 bytes of RAM. For example, the following indirect addressing instruction, where R0 contains 0A0H, accesses the data byte at address 0A0H, rather than P2 (whose address is 0A0H).

MOV @R0, #data

Note that stack operations are examples of indirect addressing, so the upper 128 bytes of data RAM are available as stack space.



Timer 0 and 1

Timer 0 and Timer 1 in the AT89C55WD operate the same way as Timer 0 and Timer 1 in the AT89C51 and AT89C52.

Timer 2

Timer 2 is a 16-bit Timer/Counter that can operate as either a timer or an event counter. The type of operation is selected by bit $C/\overline{T2}$ in the SFR T2CON (shown in Table 2). Timer 2 has three operating modes: capture, auto-reload (up or down counting), and baud rate generator. The modes are selected by bits in T2CON, as shown in Table 2.

Timer 2 consists of two 8-bit registers, TH2 and TL2. In the Timer function, the TL2 register is incremented every machine cycle. Since a machine cycle consists of 12 oscillator periods, the count rate is 1/12 of the oscillator frequency.

Table 5. Timer 2 Operating Modes

RCLK +TCLK	CP/RL2	TR2	MODE		
0	0	1	16-bit Auto-Reload		
0	1	1 16-bit Capture			
1	х	1 Baud Rate Generator			
Х	Х	0	(Off)		

In the Counter function, the register is incremented in response to a 1-to-0 transition at its corresponding external input pin, T2. In this function, the external input is sampled during S5P2 of every machine cycle. When the samples show a high in one cycle and a low in the next cycle, the count is incremented. The new count value appears in the register during S3P1 of the cycle following the one in which the transition was detected. Since two machine cycles (24 oscillator periods) are required to recognize a 1-to-0 transition, the maximum count rate is 1/24 of the oscillator frequency. To ensure that a given level is sampled at least once before it changes, the level should be held for at least one full machine cycle.

Capture Mode

In the capture mode, two options are selected by bit EXEN2 in T2CON. If EXEN2 = 0, Timer 2 is a 16-bit timer or counter which upon overflow sets bit TF2 in T2CON. This bit can then be used to generate an interrupt. If EXEN2 = 1, Timer 2 performs the same operation, but a 1-to-0 transition at external input T2EX also causes the current value in TH2 and TL2 to be captured into RCAP2H and RCAP2L, respectively. In addition, the transition at T2EX causes bit EXF2 in T2CON to be set. The EXF2 bit, like TF2, can generate an interrupt. The capture mode is illustrated in Figure 5.

Auto-reload (Up or Down Counter)

Timer 2 can be programmed to count up or down when configured in its 16-bit auto-reload mode. This feature is invoked by the DCEN (Down Counter Enable) bit located in the SFR T2MOD (see Table 6). Upon reset, the DCEN bit is set to 0 so that timer 2 will default to count up. When DCEN is set, Timer 2 can count up or down, depending on the value of the T2EX pin.





Figure 5. Timer in Capture Mode

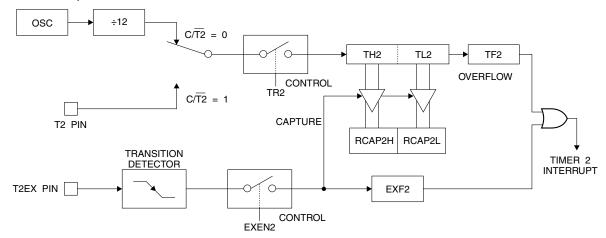


Figure 6 shows Timer 2 automatically counting up when DCEN=0. In this mode, two options are selected by bit EXEN2 in T2CON. If EXEN2 = 0, Timer 2 counts up to 0FFFFH and then sets the TF2 bit upon overflow. The overflow also causes the timer registers to be reloaded with the 16-bit value in RCAP2H and RCAP2L. The values in Timer in Capture ModeRCAP2H and RCAP2L are preset by software. If EXEN2 = 1, a 16-bit reload can be triggered either by an overflow or by a 1-to-0 transition at external input T2EX. This transition also sets the EXF2 bit. Both the TF2 and EXF2 bits can generate an interrupt if enabled.

Setting the DCEN bit enables Timer 2 to count up or down, as shown in Figure 6. In this mode, the T2EX pin controls the direction of the count. A logic 1 at T2EX makes Timer 2 count up. The timer will overflow at 0FFFH and set the TF2 bit. This overflow also causes the 16-bit value in RCAP2H and RCAP2L to be reloaded into the timer registers, TH2 and TL2, respectively.

A logic 0 at T2EX makes Timer 2 count down. The timer underflows when TH2 and TL2 equal the values stored in RCAP2H and RCAP2L. The underflow sets the TF2 bit and causes 0FFFFH to be reloaded into the timer registers.

The EXF2 bit toggles whenever Timer 2 overflows or underflows and can be used as a 17th bit of resolution. In this operating mode, EXF2 does not flag an interrupt.



Figure 7. Timer 2 Auto Reload Mode (DCEN = 1)

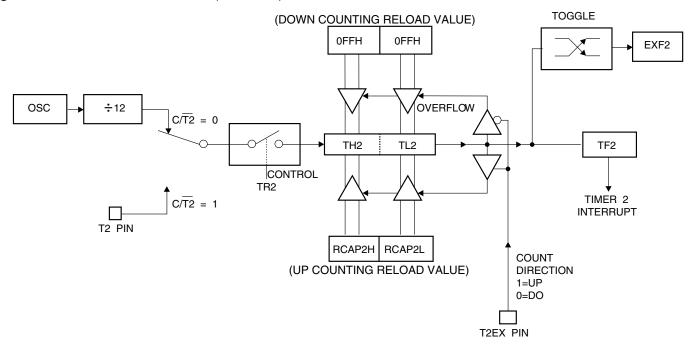


Figure 8. Timer 2 in Baud Rate Generator Mode

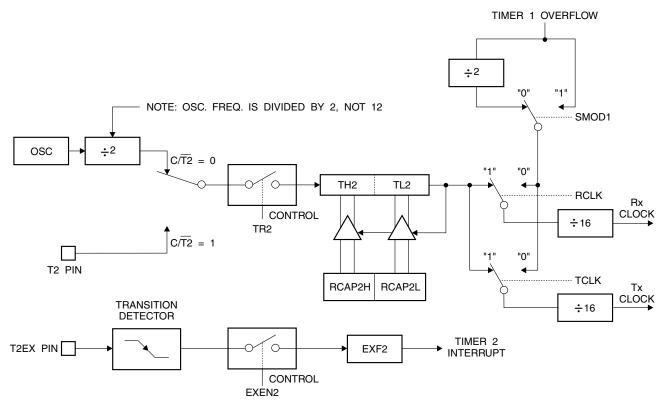
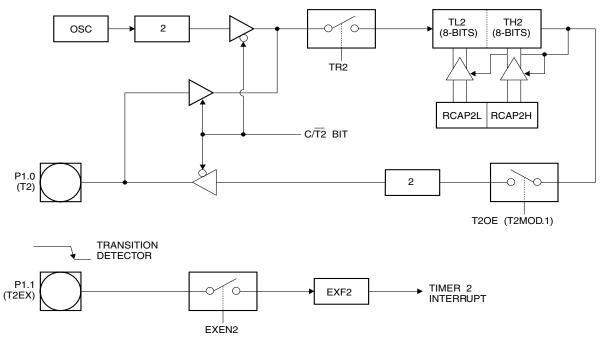




Figure 9. Timer 2 in Clock-Out Mode



Programmable Clock Out

A 50% duty cycle clock can be programmed to come out on P1.0, as shown in Figure 9. This pin, besides being a regular I/O pin, has two alternate functions. It can be programmed to input the external clock for Timer/Counter 2 or to output a 50% duty cycle clock ranging from 61 Hz to 4 MHz for a 16 MHz operating frequency.

To configure the Timer/Counter 2 as a clock generator, bit $C/\overline{T2}$ (T2CON.1) must be cleared and bit T2OE (T2MOD.1) must be set. Bit TR2 (T2CON.2) starts and stops the timer.

The clock-out frequency depends on the oscillator frequency and the reload value of Timer 2 capture registers (RCAP2H, RCAP2L), as shown in the following equation.

Clock-Out Frequency =
$$\frac{\text{Oscillator Frequency}}{4 \times [65536-(\text{RCAP2H}, \text{RCAP2L})]}$$

In the clock-out mode, Timer 2 roll-overs will not generate an interrupt. This behavior is similar to when Timer 2 is used as a baud-rate generator. It is possible to use Timer 2 as a baud-rate generator and a clock generator simultaneously. Note, however, that the baud-rate and clock-out frequencies cannot be determined independently from one another since they both use RCAP2H and RCAP2L.

Interrupts

The AT89C55WD has a total of six interrupt vectors: two external interrupts (INT0 and INT1), three timer interrupts (Timers 0, 1, and 2), and the serial port interrupt. These interrupts are all shown in Figure 10.

Each of these interrupt sources can be individually enabled or disabled by setting or clearing a bit in Special Function Register IE. IE also contains a global disable bit, EA, which disables all interrupts at once.

Note that Table 5 shows that bit position IE.6 is unimplemented. User software should not write a '1' to this bit position, since it may be used in future AT89 products.

Timer 2 interrupt is generated by the logical OR of bits TF2 and EXF2 in register T2CON. Neither of these flags is cleared by hardware when the service routine is vectored to. In fact, the service routine may have to determine whether it was TF2 or EXF2 that generated the interrupt, and that bit will have to be cleared in software.

The Timer 0 and Timer 1 flags, TF0 and TF1, are set at S5P2 of the cycle in which the timers overflow. The values are then polled by the circuitry in the next cycle. However, the Timer 2 flag, TF2, is set at S2P2 and is polled in the same cycle in which the timer overflows.





puts, and the next cycle may begin. Data Polling may begin any time after a write cycle has been initiated.

Ready/Busy: The progress of byte programming can also be monitored by the RDY/BSY output signal. P3.0 is pulled low after ALE goes high during programming to indicate BUSY. P3.0 is pulled high again when programming is done to indicate READY.

Program Verify: If lock bits LB1 and LB2 have not been programmed, the programmed code data can be read back via the address and data lines for verification. The status of the individual lock bits can be directly verified by reading them back.

Reading the Signature Bytes: The signature bytes are read by the same procedure as a normal verification of locations 000H, 100H, and 200H, except that P3.6 and P3.7 must be pulled to a logic low. The values returned are as follows:

(000H) = 1EH indicates manufactured by Atmel

(100H) = 55H

(200H) = 06H indicates 89C55WD

Programming Interface

Every code byte in the Flash array can be programmed by using the appropriate combination of control signals. The write operation cycle is self-timed and once initiated, will automatically time itself to completion.

Most worldwide major programming vendors offer support for the Atmel microcontroller series. Please contact your local programming vendor for the appropriate software revision.

Table 10. Flash Programming Modes

				ALE/	ĒĀ/						P0.7-0	P3.4	P2.5-0	P1.7-0	
Mode	V _{cc}	RST	PSEN	PROG	V _{PP}	P2.6	P2.7	P3.3	P3.6	P3.7	Data	Address			
Write Code Data	5V	Н	L	(1)	12V	L	Н	Н	Н	Н	D _{IN}	A14	A13-8	A7-0	
Read Code Data	5V	Н	L	Н	H/12V	L	L	L	Н	Н	D _{OUT}	A14	A13-8	A7-0	
Write Lock Bit 1	6.5V	Н	L	(2)	12V	Н	Н	Н	Н	Н	х	х	х	х	
Write Lock Bit 2	6.5V	Н	L	(2)	12V	Н	Н	Н	L	L	х	х	х	х	
Write Lock Bit 3	6.5V	Н	L	(2)	12V	Н	L	Н	Н	L	х	х	х	х	
Read Lock Bits 1, 2, 3	5V	Н	L	н	Н	Н	Н	L	Н	L	P0.2, P0.3, P0.4	х	x	х	
Chip Erase	6.5V	Н	L	(3)	12V	Н	L	Н	L	L	х	х	х	х	
Read Atmel ID	5V	Н	L	Н	Н	L	L	L	L	L	1EH	Х	XX 0000	00H	
Read Device ID	5V	Н	L	Н	Н	L	L	L	L	L	55H	Х	XX 0001	00H	
Read Device ID	5V	Н	L	Н	Н	L	L	L	L	L	06H	х	XX 0010	00H	

Notes: 1. Write Code Data requires a 200 ns PROG pulse.

- 2. Write Lock Bits requires a 100 µs PROG pulse.
- 3. Chip Erase requires a 200 ns 500 ns PROG pulse.
- 4. RDY/BSY signal is output on P3.0 during programming.



Figure 13. Programming the Flash Memory

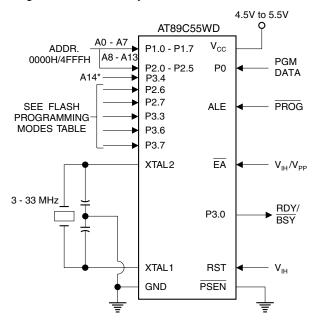
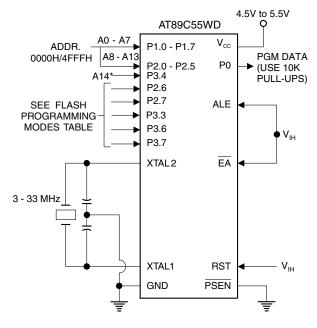


Figure 14. Verifying the Flash Memory



Note: *Programming address line A14 (P3.4) is not the same as the external memory address line A14 (P2.6).

Flash Programming and Verification Characteristics

 $T_A = 20^{\circ}C$ to $30^{\circ}C$, $V_{CC} = 4.5V$ to 5.5V

Symbol	Parameter	Min	Max	Units
V _{PP}	Programming Supply Voltage	11.5	12.5	V
I _{PP}	Programming Supply Current		10	mA
I _{cc}	V _{CC} Supply Current		30	mA
1/t _{CLCL}	Oscillator Frequency	3	33	MHz
t _{AVGL}	Address Setup to PROG Low	48t _{CLCL}		
t _{GHAX}	Address Hold After PROG	48t _{CLCL}		
t _{DVGL}	Data Setup to PROG Low	48t _{CLCL}		
t _{GHDX}	Data Hold After PROG	48t _{CLCL}		
t _{EHSH}	P2.7 (ENABLE) High to V _{PP}	48t _{CLCL}		
t _{SHGL}	V _{PP} Setup to PROG Low	10		μs
t _{GHSL}	V _{PP} Hold After PROG	10		μs
t _{GLGH}	PROG Width	0.2	1	μs
t _{AVQV}	Address to Data Valid		48t _{CLCL}	
t _{ELQV}	ENABLE Low to Data Valid		48t _{CLCL}	
t _{EHQZ}	Data Float After ENABLE	0	48t _{CLCL}	
t _{GHBL}	PROG High to BUSY Low		1.0	μs
t _{wc}	Byte Write Cycle Time		80	μs



AC Characteristics

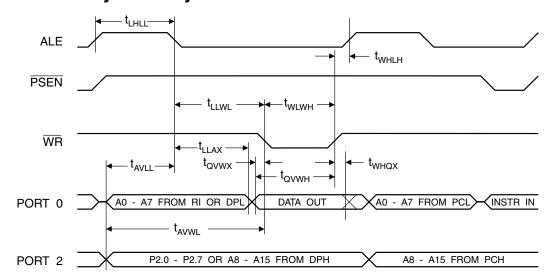
Under operating conditions, load capacitance for Port 0, ALE/ \overline{PROG} , and \overline{PSEN} = 100 pF; load capacitance for all other outputs = 80 pF.

External Program and Data Memory Characteristics

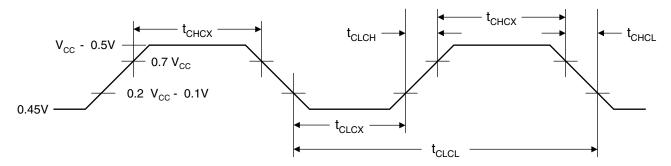
		12 MHz	Oscillator	Variable	Oscillator	
Symbol	Parameter	Min	Max	Min	Max	Units
1/t _{CLCL}	Oscillator Frequency			0	33	MHz
t _{LHLL}	ALE Pulse Width	127		2t _{CLCL} -40		ns
t _{AVLL}	Address Valid to ALE Low	43		t _{CLCL} -25		ns
t _{LLAX}	Address Hold After ALE Low	48		t _{CLCL} -25		ns
t _{LLIV}	ALE Low to Valid Instruction In		233		4t _{CLCL} -65	ns
t _{LLPL}	ALE Low to PSEN Low	43		t _{CLCL} -25		ns
t _{PLPH}	PSEN Pulse Width	205		3t _{CLCL} -45		ns
t _{PLIV}	PSEN Low to Valid Instruction In		145		3t _{CLCL} -60	ns
t _{PXIX}	Input Instruction Hold After PSEN	0		0		ns
t _{PXIZ}	Input Instruction Float After PSEN		59		t _{CLCL} -25	ns
t _{PXAV}	PSEN to Address Valid	75		t _{CLCL} -8		ns
t _{AVIV}	Address to Valid Instruction In		312		5t _{CLCL} -80	ns
t _{PLAZ}	PSEN Low to Address Float		10		10	ns
t _{RLRH}	RD Pulse Width	400		6t _{CLCL} -100		ns
t _{WLWH}	WR Pulse Width	400		6t _{CLCL} -100		ns
t _{RLDV}	RD Low to Valid Data In		252		5t _{CLCL} -90	ns
t _{RHDX}	Data Hold After RD	0		0		ns
t _{RHDZ}	Data Float After RD		97		2t _{CLCL} -28	ns
t _{LLDV}	ALE Low to Valid Data In		517		8t _{CLCL} -150	ns
t _{AVDV}	Address to Valid Data In		585		9t _{CLCL} -165	ns
t _{LLWL}	ALE Low to RD or WR Low	200	300	3t _{CLCL} -50	3t _{CLCL} +50	ns
t _{AVWL}	Address to RD or WR Low	203		4t _{CLCL} -75		ns
t _{QVWX}	Data Valid to WR Transition	23		t _{CLCL} -30		ns
t _{QVWH}	Data Valid to WR High	433		7t _{CLCL} -130		ns
t _{WHQX}	Data Hold After WR	33		t _{CLCL} -25		ns
t _{RLAZ}	RD Low to Address Float		0		0	ns
t _{WHLH}	RD or WR High to ALE High	43	123	t _{CLCL} -25	t _{CLCL} +25	ns



External Data Memory Write Cycle



External Clock Drive Waveforms



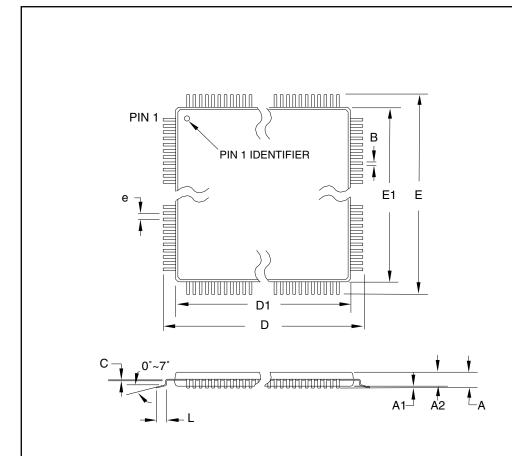
External Clock Drive

Symbol	Parameter	Min	Max	Units
1/t _{CLCL}	Oscillator Frequency	0	33	MHz
t _{CLCL}	Clock Period	30		ns
t _{CHCX}	High Time	12		ns
t _{CLCX}	Low Time	12		ns
t _{CLCH}	Rise Time		5	ns
t _{CHCL}	Fall Time		5	ns



Package Information

44A - TQFP



COMMON DIMENSIONS

(Unit of Measure = mm)

SYMBOL	MIN	NOM	MAX	NOTE
Α	_	_	1.20	
A1	0.05	_	0.15	
A2	0.95	1.00	1.05	
D	11.75	12.00	12.25	
D1	9.90	10.00	10.10	Note 2
E	11.75	12.00	12.25	
E1	9.90	10.00	10.10	Note 2
В	0.30	_	0.45	
С	0.09	_	0.20	
L	0.45	_	0.75	
е		0.80 TYP		

10/5/2001

Notes:

- 1. This package conforms to JEDEC reference MS-026, Variation ACB.
- 2. Dimensions D1 and E1 do not include mold protrusion. Allowable protrusion is 0.25 mm per side. Dimensions D1 and E1 are maximum plastic body size dimensions including mold mismatch.
- 3. Lead coplanarity is 0.10 mm maximum.

<u>AIMEL</u>	2325 Orchard San Jose, CA	Parkway
	San Jose, CA	95131

TITLE
44A , 44-lead, 10 x 10 mm Body Size, 1.0 mm Body Thickness,
0.8 mm Lead Pitch, Thin Profile Plastic Quad Flat Package (TQFP)

DRAWING NO.	REV.
44A	В



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